



Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
USPTO Use Only

1739  
H#

RECEIVED

NOV 08 2002

TC 1700

EFS ID: 19590  
Application ID: 10087050  
Title of Invention: METHOD OF MAKING A  
COMPOSITE PANEL AND ARTICLE  
MADE THEREBY  
First Named Inventor: Phillip Carroll  
Domestic/Foreign Application: Domestic Application  
Filing Date: 2002-03-01  
Effective Receipt Date: 2002-11-06  
Submission Type: Information Disclosure Statement  
Filing Type: null  
Confirmation Number: 3233  
Attorney Docket Number: OAKW0124PUS  
Digital Certificate Holder: cn=Matthew R. Mowers, ou=Registered Attorneys, ou=Patent and  
Trademark Office, ou=Department of Commerce, o=U.S.  
Government, c=US  
Certificate Message Digest: S3nQMWTYXrybybO5+tX44Q==





# TRANSMITTAL FORM

Electronic Version 1.0.3

Stylesheet Version: 1.0

Submission Type: Information  
Disclosure Statement

**RECEIVED**

NOV 0 8 2002

**TC 1700**

Application Number: 10087050  
Attorney Docket Number: OAKW0124PUS

## **METHOD OF MAKING A COMPOSITE PANEL AND ARTICLE MADE THEREBY**

First Named Inventor: Phillip Patrick Carroll III

### SUBMITTED BY

Name: Matthew R. Mowers  
Registration Number: 44956  
Electronic Signature  
Mark: /s/Matthew R. Mowers  
Date Signed: 20021106

*I certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.*

*I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.*

### Attached Files:

us-information-disclosure-statement

OAKW0124PUSids.xml

Comments: